### MOSFET – Power, Single, N-Channel, DPAK/IPAK 30 V, 117 A

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- AEC Q101 Qualified NVD4804N
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

- CPU Power Delivery
- DC-DC Converters
- Low Side Switching

Drain-to-Source Voltage

Gate-to-Source Voltage

Current (R<sub>0JA</sub>) (Note 1)

Current (R<sub>0JA</sub>) (Note 2)

Continuous Drain

Power Dissipation

Continuous Drain

Power Dissipation

Continuous Drain

Power Dissipation

Pulsed Drain Current

Drain to Source dV/dt

(1/8" from case for 10 s)

Current Limited by Package

Source Current (Body Diode)

Energy ( $V_{DD}$  = 24 V,  $V_{GS}$  = 10 V,

L = 1.0 mH,  $I_{L(pk)}$  = 30 A,  $R_{G}$  = 25  $\Omega$ )

(R<sub>0JC</sub>) (Note 1)

(R<sub>0JA</sub>) (Note 2)

Current (R<sub>0JC</sub>)

(Note 1)

(R<sub>0JA</sub>) (Note 1)

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Steady State

t<sub>p</sub>=10μs

Operating Junction and Storage Temperature

Single Pulse Drain-to-Source Avalanche

Lead Temperature for Soldering Purposes

Symbol

V<sub>DSS</sub>

V<sub>GS</sub>

Ъ

PD

IЬ

PD

h

 $P_D$ 

IDM

I<sub>DmaxPkg</sub>

T<sub>J</sub>, T<sub>stg</sub>

 $I_S$ 

dV/dt

E<sub>AS</sub>

 $T_L$ 

T<sub>A</sub> = 25°C

T<sub>A</sub> = 85°C

T<sub>A</sub> = 25°C

T<sub>A</sub> = 25°C

T<sub>A</sub> = 85°C

T<sub>A</sub> = 25°C

T<sub>C</sub> = 25°C

T<sub>C</sub> = 85°C

 $T_C = 25^{\circ}C$ 

 $T_A = 25^{\circ}C$ 

 $T_A = 25^{\circ}C$ 

Value

30

±20

19.6

15.2

2.66

14.5

11

1.43

124

96

107

230

45

–55 to

175

78

6.0

450

260

Unit V

V

A

W

A

W

A

w

А

A

°C

А

V/ns

mJ

°C

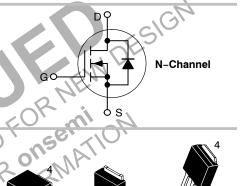
Parameter

0	N	

#### **ON Semiconductor®**

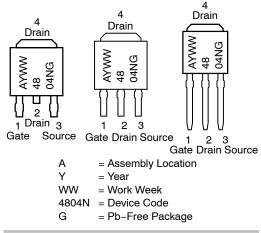
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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX	
30 V	4.0 m $\Omega$ @ 10 V	117 A	
30 V	5.5 mΩ @ 4.5 V	Π/A	



1 201	UUU	1 <sup>°</sup> // 2 3
CASE 369AA DPAK (Bent Lead) STYLE 2	CASE 369AD 3 IPAK (Straight Lead)	CASE 369D IPAK (Straight Lead DPAK)





#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

Stresses exceeding those listed in the Maximum Ratings table may damage the
device. If any of these limits are exceeded, device functionality should not be
assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	R <sub>θJC</sub>	1.4	°C/W
Junction-to-TAB (Drain)	$R_{\theta JC-TAB}$	3.5	
Junction-to-Ambient - Steady State (Note 1)	R <sub>θJA</sub>	56.4	
Junction-to-Ambient - Steady State (Note 2)	$R_{ extsf{ heta}JA}$	105	

Surface-mounted on FR4 board using 1 in sq pad size, 1 oz Cu.
 Surface-mounted on FR4 board using the minimum recommended pad size.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				•	
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>			26		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V, V_{DS} = 24 V T_{J} = 25^{\circ}C T_{J} = 125^{\circ}C $			1,0 510	μA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ±20 V			± 100	nA
ON CHARACTERISTICS (Note 3)				N.		1
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS}$ = $V_{DS}$ , $I_D$ = 250 $\mu$ A	1.5		2.5	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>		FOR	7.6		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ to } 11.5 \text{ V}$ $I_D = 30 \text{ A}$ $I_D = 15 \text{ A}$ $V_{CS} = 4.5 \text{ V}$ $I_D = 30 \text{ A}$	L 2M	3.4 3.4 4.7	4.0	mΩ

4.7

4.6 23

5.5

S

		$v_{GS} = 4.5 V$ $I_D = 30 A$	
		I <sub>D</sub> = 15 A	
Forward Transconductance	gFS	V <sub>DS</sub> = 15-V, I <sub>D</sub> = 15 A	

~

#### CHARGES AND CAPACITANCES

Input Capacitance	Ciss	C ANY	4490		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 12 V	952		
Reverse Transfer Capacitance	C <sub>rss</sub>		556		
Total Gate Charge	Q <sub>G(TØT)</sub>		30	40	nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V,	5.5		
Gate-to-Source Charge	Q <sub>GS</sub>	I <sub>D</sub> = 30 A	13		
Gate-to-Drain Charge	Q <sub>GD</sub>		13		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 11.5 V, V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	73		nC

1

#### SWITCHING CHARACTERISTICS (Note 4)

Turn-On Delay Time	t <sub>d(on)</sub>		18	ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V,	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm D} = 15 \text{ A}, \text{ R}_{\rm G} = 3.0 \Omega$	24	
Fall Time	t <sub>f</sub>		8	
Turn-On Delay Time	t <sub>d(on)</sub>		10	ns
Rise Time	t <sub>r</sub>	$V_{GS}$ = 11.5 V, $V_{DS}$ = 15 V, I <sub>D</sub> = 15 A, R <sub>G</sub> = 3.0 Ω	19	
Turn-Off Delay Time	t <sub>d(off)</sub>		35	
Fall Time	t <sub>f</sub>		5	

3. Pulse Test: Pulse Width  $\leq$  300  $\mu s,$  Duty Cycle  $\leq$  2%.

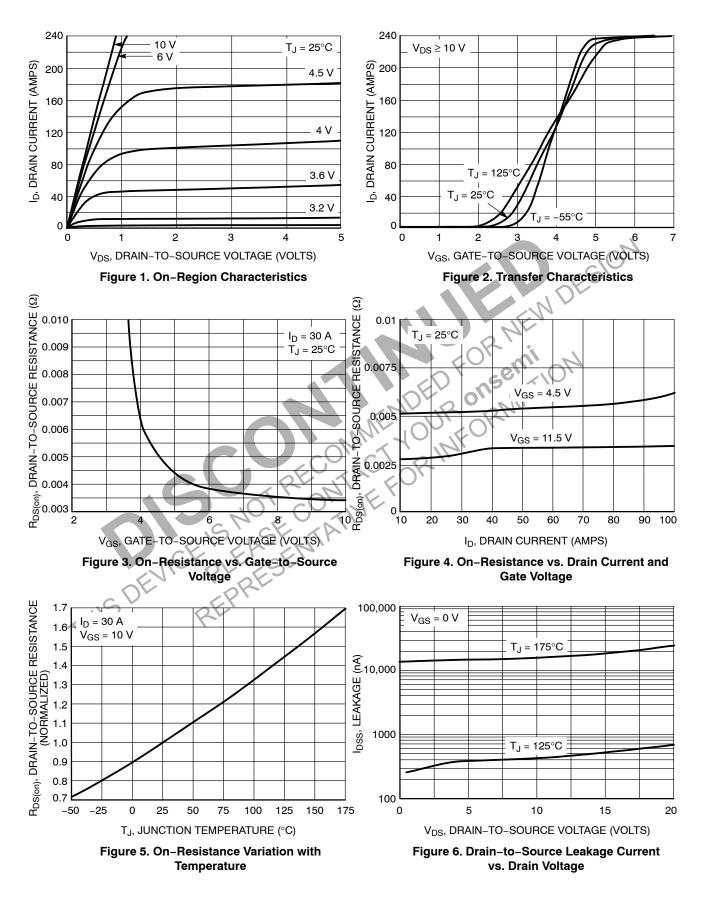
4. Switching characteristics are independent of operating junction temperatures.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted)

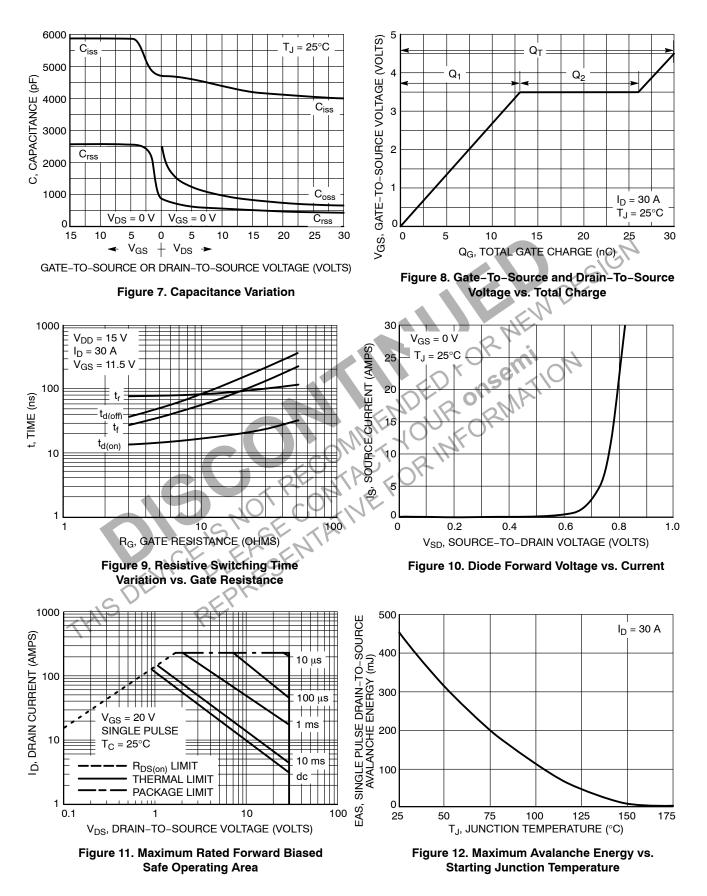
Parameter	Symbol	Test Co	ndition	Min	Тур	Max	Unit
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.81	1.2	V
		I <sub>S</sub> = 30 A	T <sub>J</sub> = 125°C		0.72		
Reverse Recovery Time	t <sub>RR</sub>				34		ns
Charge Time	ta	V <sub>GS</sub> = 0 V, dls/	/dt = 100 A/μs,		19		
Discharge Time	tb	I <sub>S</sub> = 5			15		
Reverse Recovery Time	Q <sub>RR</sub>				30		nC
PACKAGE PARASITIC VALUES					•		
Source Inductance	L <sub>S</sub>				2.49		nH
Drain Inductance, DPAK	L <sub>D</sub>				0.0164		
Drain Inductance, IPAK	L <sub>D</sub>	T <sub>A</sub> = 1	25°C		1.88		
Gate Inductance	L <sub>G</sub>				3.46	G	•
Gate Resistance	R <sub>G</sub>	1			0.6	S,	Ω

inditions, unless of conditions, unless of c Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

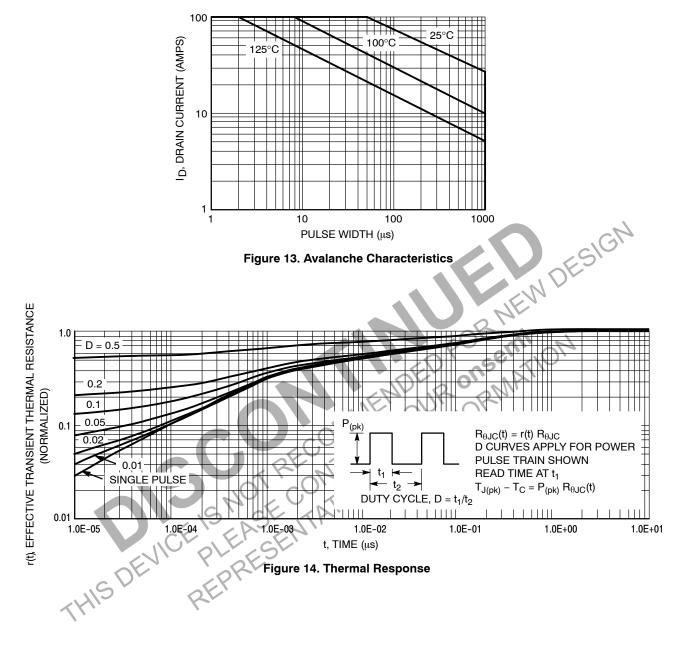
#### **TYPICAL PERFORMANCE CURVES**



#### **TYPICAL PERFORMANCE CURVES**



#### **TYPICAL PERFORMANCE CURVES**



#### **ORDERING INFORMATION**

Order Number	Package	Shipping <sup>†</sup>
NTD4804NT4G	DPAK (Pb-Free)	2500 / Tape & Reel
NTD4804N-35G	IPAK Trimmed Lead (3.5 ± 0.15 mm) (Pb-Free)	75 Units / Rail
NVD4804NT4G	DPAK (Pb-Free)	2500 / Tape & Reel
NVD4804NT4G-VF01	DPAK (Pb-Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



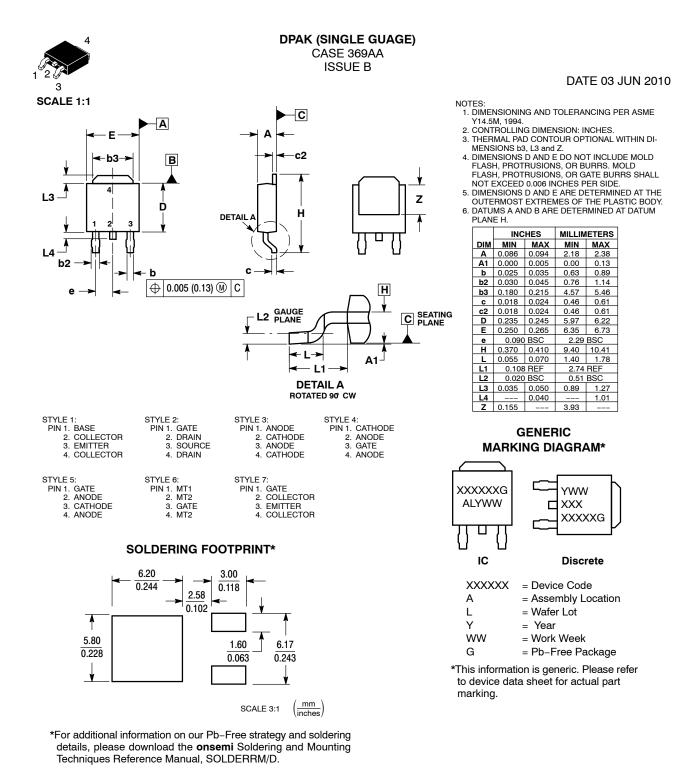
#### **DPAK INSERTION MOUNT CASE 369** ISSUE O DATE 02 JAN 2000 SCALE 1:1 С $B \rightarrow$ NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. Е R MILLIMETERS INCHES л DIM MIN MAX MIN MAX A 0.235 0.250 B 0.250 0.265 5.97 6.35 Δ 6.35 6.73 C 0.086 0.094 D 0.027 0.035 2.19 0.69 2.38 2 3 0.88 S E 0.033 0.040 F 0.037 0.047 0.84 1.01 0.94 -T-1.19 G 0.090 BSC 2.29 BSC SEATING H 0.034 0.040 J 0.018 0.023 0.87 1.01 0.46 0.58 K 0.350 0.380 8.89 9.65 **R** 0.175 0.215 4.45 5.46 0.050 0.090 1.27 J S 2.28 F V 0.030 0.050 н 0.77 1.27 D 3 PL G 🔫 ⊕ 0.13 (0.005) M T

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:		STYLE 5:		STYLE 6:	
PIN 1.	BASE	PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	GATE	PIN 1.	MT1
2.	COLLECTOR	2.	DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE	2.	MT2
3.	EMITTER	3.	SOURCE	3.	ANODE	3.	GATE	3.	CATHODE	3.	GATE
4.	COLLECTOR	4.	DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE	4.	MT2

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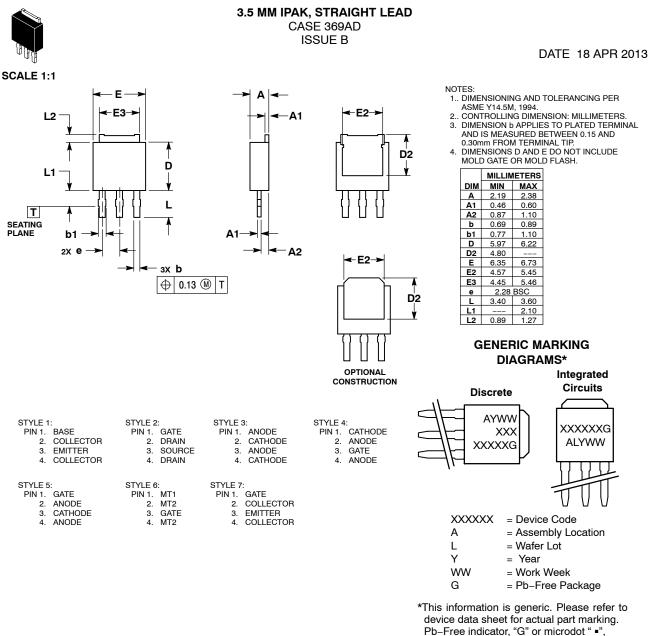


 
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